Declaration and Power of Attorney For Patent Application English Language Declaration

As a below gamed inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled A SIMULATED CIRCUIT LAYOUT FOR LOW VOLTAGE, LOW POWER AND HIGH PERFORMANCE TYPE II CURRENT CONVEYOR, the specification of which is attached hereto unless the following box is checked: was filed on March 28, 2001 as United States Application Number 09/820,253. I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56. I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed: Prior Foreign Application(s) **Priority Not Claimed** (Number) (Country) (Day/Month/Year Filed) (Number) (Country) (Day/Month/Year Filed)

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

(Application Number)

(Filing Date)

(Application Number)

(Filing Date)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

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	ecute this appli			int the following at the Patent and T	
Paul F. Prestia Allan Ratner Andrew L. Ney Kenneth N. Nigon Kevin R. Casey Benjamin E. Leace James C. Simmons	Reg. No. 23,031 Reg. No. 19,717 Reg. No. 20,300 Reg. No. 31,549 Reg. No. 32,117 Reg. No. 33,412 Reg. No. 24,842	Lawrence E. Ashery Christopher R. Lewis Robert L. Andersen Joshua L. Cohen Daniel N. Calder Louis W. Beardell, Jr. Jacques L. Etkowicz	Reg. No. 34,515 Reg. No. 36,201 Reg. No. 25,771 Reg. No. 38,040 Reg. No. 27,424 Reg. No. 40,506 Reg. No. 41,738	Jack J. Jankovitz Jonathan H. Spadt Christopher I. Halliday Scott A. Mckeown	Reg. No. 4 Reg. No. 4 Reg. No. 4 Reg. No. 4
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